

PACSystems™ IPC 6010, IPC 7010, IPC 8010

An AI ready platform for Powerful, Reliable, Ruggedized Computing

Emerson's next-generation Industrial PC (IPC) platform includes the IPC 6010, IPC 7010, and IPC 8010, each delivering high-performance computing and graphical capabilities in a ruggedized package. Like other award-winning products in the PACSystems IPC product line, this computing platform boasts high reliability and a long deployment life thanks to fanless cooling and soldered memory. Its industrial grade features include the processor, the memory, and even the operating system, which can come paired with pre-loaded, pre-licensed edge software, that enables customized data collection and aggregation, data protocol conversion, and advanced analytics applications for real time optimization and visualization of operations.

These high powered IPCs are well suited to processing time-series data from various sources like PLCs, cameras, sensors, flow meters or valve manifolds, powering HMI, Historian, and analytical solutions for remote monitoring, leak detection, and preventative maintenance applications.



High-Performance Computing

Experience unparalleled performance with PACSystems AI generation IPCs, powered by the 13th Generation Intel® Core™ Processors. Benefit from up to 64GB of ECC RAM, five 2.5Gbps Ethernet interfaces, and industrial-grade high-speed SSD storage, ensuring your industrial applications run smoothly even in the harshest environments. Enjoy the flexibility of up to 4 PCIe slots, which are field upgradeable and support high performance NPU or GPU plug-in cards. Advanced CPUs combined with PCIe expandability deliver high performance computing tailored to your requirements. Keep your data and operations secure with Trusted Platform Module (TPM) and Microsoft Secure Boot technology.

Software Options and Benefits

PACSystems AI generation IPCs come with everything you need to start creating value out of the box. An IIoT-ready Linux operating system and PACEdge application enablement platform come pre-installed from the factory. In addition, there are options to add pre-loaded and pre-licensed Movicon® Connex and Movicon WebHMI software, enabling additional functionality and benefits as detailed in the following table.

Product Name	Functionality and Benefits
PACEdge	An application enablement platform for the development of scalable data intensive Industry 4.0 solutions. It provides integration between OT and IT domains without disrupting OT assets, architectures or systems while satisfying IT cybersecurity, communications and application requirements. PACEdge is capable of supporting integrations and architectures ranging from IIoT gateways and remote monitoring to edge AI/ML analytics and data visualization. The PACEdge software environment provides all the tools necessary to collect, store, process, share, visualize, secure and integrate data allowing users to focus on applications and solutions instead of tools and platforms.
PACEdge with Movicon Connex and WebHMI	<p>A comprehensive solution for delivering visualization and data collection that also maintains a seamless, intuitive experience. Whether users are accessing critical data directly in the plant, collecting information via a workstation in a control room, or checking system performance via mobile device from outside the facility, powerful visualization tools ensure a consistent display for fast delivery and interpretation of critical data.</p> <p>A gateway communications center for Machine to Machine, Cloud and IIOT connectivity systems that facilitates data collection, analysis, and reporting. Connex quickly and intuitively links a multitude of devices for better data flow. With its built-in protocol libraries, Connex can collect and publish data to the cloud, manage information flows to business systems, or connect field devices to software applications or to each other effortlessly and safely.</p>

Replace with Reliability

PACSystems IPCs are engineered for reliability in demanding environments. Their high-quality industrial components, rugged design, and fanless operation ensure consistent performance for both commercial and industrial applications. This next-generation IPC platform is built for long-lasting reliability.

Lower Total Cost of Ownership (TCO)

Built on Emerson's rugged monolithic base board and patented thermal management system housing, PACSystems IPCs enhance productivity and reduce TCO. Key features such as pre-loaded and pre-licensed edge software, low maintenance, and low power consumption contribute to lower operating costs and higher efficiency.




Feature	Benefit
13th Generation Intel® Core™ Processors	13th Gen Intel® Core™ mobile processors for IoT edge drive consistent performance and offer accelerated AI, immersive graphics, and industrial-grade capabilities in a compact, ruggedized form factor with a range of power bases. Coupled with our patented cooling technology, our performance is best-in-class.
Fanless operation	A robust, reliable solution with no moving parts and minimized dust contamination.
Five 2.5 Gigabit Ethernet ports (all with Time SYNC IEEE1588 and one with AMT)	Network implementation flexibility. Multiple high-speed Ethernet links for communication-centric applications with support for deterministic transfer of data/commands.
Small Form Factor	Mounting options provide flexibility for where the IPC can be installed. DIN Rail, Panel and VESA Mounting available.

Specifications¹

Processor: 13th Generation Intel® Core™ Processors with 15/28/45W TDP		
IPC 6010 (15W TDP)	IPC 7010 (28W TDP)	IPC 8010 (45W TDP)
A: U300E 1xPC, 4xEC, CT	J: i3-1320PE 4xPC, 4xEC, CT	R: i3-13300HE 4xPC, 4xEC, CT
B: i3-1315UE 2xPC, 4xEC, CT	L: i5-1350PE 4xPC, 8xEC, CT	S: i5-13600HE 4xPC, 8xEC, CT
D: i5-1345UE 2xPC, 8xEC, CT	M: i7-1370PE 6xPC, 8xEC, CT	T: i7-13800HE 6xPC, 8xEC, CT
E: i7-1365UE 2xPC, 8xEC, CT	N: i3-1320PRE 4xPC, 4xEC, ET	U: i3-13300HRE 4xPC, 4xEC, ET
G: i3-1315URE 2xPC, 4xEC, ET	P: i5-1350PRE 4xPC, 8xEC, ET	V: i5-13600HRE 4xPC, 8xEC, ET
H: i5-1345URE 2xPC, 8xEC, ET	Q: i7-1370PRE 6xPC, 8xEC, ET	W: i7-13800HRE 6xPC, 8xEC, ET
I: i7-1365URE 2xPC, 8xEC, ET		

PC (Performance Cores); EC (Efficient Cores); CT (Standard Temperature); ET (Extended Temperature)

Memory	
Up to 64GB LPDDR5-6400, soldered with ECC	
Storage Interfaces	
Primary storage device – M.2 NVMe 16GT/s	
Micro-SD slot, user accessible, supports OS boot, hot plug	
Ethernet	
Five 10/100/1000/2500BASE-T Ethernet ports, option to enable AMT remote management functionality on one port	
Wireless Communication	
Models are available with optional WiFi6E connectivity (802.11ac/ax/a/b/g/n & Bluetooth 5.3)	
Graphics Interface	
Two DisplayPort++ HBR3 support (4 independent displays)	
USB Interface	
Four USB 3.2 Gen 2x1 (10Gbit/s)	
Thunderbolt™ 4 Interface	
Two Thunderbolt 4	
Serial Communications	
Two RS232	Two galvanically isolated RS422/485
Expansion	
Up to four field upgradeable PCIe slots	
User-Defined LED	
One combined green and red color user-defined LED	

Others			
OS and application watchdog timers	Thermal monitoring	RTC with Lithium coin cell battery	
Power			
Input: 24 VDC (±25%) with surge protection		9-30 VDC wide range standard for 6010 base unit (w/o slot extension)	
Environmental			
Thermal performance is highly dependent on end application workload, pre-configured processor TDP value, installed expansion cards, IPC mounting orientation etc. Please consult Hardware Reference Manual for details and recommendations.	Range	Operating ²	Storage
	Standard	0°C up to +70°C	-40°C up to +85°C
	Extended	-40°C up to +70°C	-40°C up to +85°C
	Humidity	5-95% @ +40°C	5-95% @ +40°C
	Altitude	6,600 ft. (2 km)	40000 ft. (12 km)
Firmware			
UEFI AMI Aptio® V			
Base Unit			
Base Unit - w/o Extension	6010 (Efficiency)	7010 (Balanced)	8010 (Performance)
			
Mechanical			
Rugged aluminum and stainless steel housing for optimal thermal management and durability			
IP20 – Protection against particles			

1 Additional features may be added by customization, please contact your regional sales representative to inquire.

2 Operating temperature is dependent on the CPU and SSD choice, application software, orientation of the heat sink fins at free convection. For detailed recommendations please refer to Hardware Reference Manual or contact support team.

Extension Availability & Dimensions H x W x D (mm)			
	IPC 6010	IPC 7010	IPC 8010
Base Unit - w/o Extension	191 x 158 x 44.4 (mm)*	191 x 158 x 60 (mm)	191 x 158 x 60 (mm)
1 Slot Extension	191 x 158 x 76.8 (mm)	191 x 158 x 92.4 (mm)	191 x 158 x 92.4 (mm)
2 Slot Extension	N/A	191 x 158 x 112.7 (mm)	191 x 158 x 112.7 (mm)
3 Slot Extension	N/A	191 x 158 x 133 (mm)	191 x 158 x 133 (mm)
4 Slot Extension	N/A	N/A	191 x 158 x 153.3 (mm)

Power Supply: 24 VDC +/-25% (Standard)

* 9-30 VDC (Wide Range)

Weight (kg)			
	IPC 6010	IPC 7010	IPC 8010
Base Unit - w/o Extension	2.1 kg	2.5 kg	2.5 kg
1 Slot Extension	2.8 kg	3.2 kg	3.2 kg
2 Slot Extension	N/A	3.4 kg	3.4 kg
3 Slot Extension	N/A	3.6 kg	3.6 kg
4 Slot Extension	N/A	N/A	3.8 kg






Mounting Options			
	IPC 6010	IPC 7010	IPC 8010
Base Unit - w/o Extension	DIN Rail*, VESA***, Panel - Mount*	DIN Rail*, VESA***, Panel - Mount*	DIN Rail*, VESA***, Panel - Mount*
1 Slot Extension	DIN Rail*, VESA***, Panel - Mount*	DIN Rail**, VESA***, Panel - Mount**	DIN Rail**, VESA***, Panel - Mount**
2 Slot Extension	N/A	DIN Rail**, VESA***, Panel - Mount**	DIN Rail**, VESA***, Panel - Mount**
3 Slot Extension	N/A	DIN Rail**, VESA***, Panel - Mount**	DIN Rail**, VESA***, Panel - Mount**
4 Slot Extension	N/A	N/A	DIN Rail**, VESA***, Panel - Mount**

Mounting Options: VESA 100 mm x 100 mm (4 x M6)

* Reduced S&V levels

** Qty 2 of the Mounting Kit are needed

*** Fan Accessory cannot be used with VESA mounting

Slot Extensions				
				
Qty PCIe Slots	1	2	3	4
Slot 1	Gen4x4	Gen4x4	Gen4x4	Gen4x4
Slot 2	N/A	Gen3x1	Gen3x1	Gen3x1
Slot 3	N/A	N/A	Gen3x1	Gen3x1
Slot 4	N/A	N/A	N/A	Gen4x8

Full height, half length PCIe cards are supported, maximum power budget per slot extension 25 W (for more details consult manual)

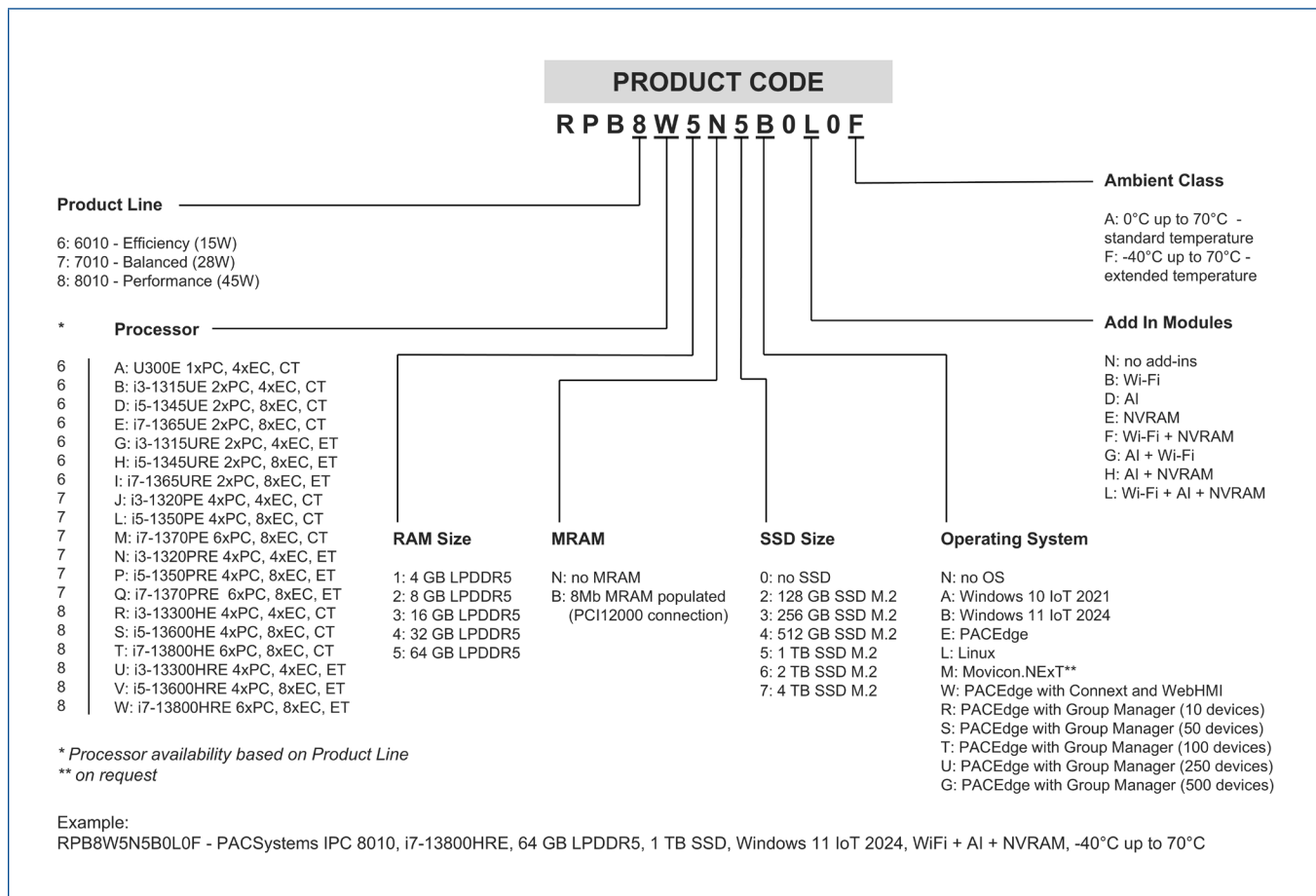


The PACSystems™ IPC family is a fanless design which operates up to 70°C with the IPC 6010. The optional Fan Accessory enables a high ambient temperature of 70°C for all product flavors, independent from product line, usage of slot extensions and mounting kit. Furthermore, the usage of a Fan Accessory will result in lower unit and therefore component temperatures. Fan Accessory cannot be used with VESA mounting.

Software Support					
Windows® 10 IoT Enterprise 2021 LTSC	Windows® 11 IoT Enterprise 2024 LTSC	Linux® 24.04 LTS, and above	VxWorks® 7.0 <i>on request</i>	PACEdge	PACEdge with Movicon Connex and WebHMI

Safety & EMC		
IEC/UL62368	CE, FCC	<ul style="list-style-type: none"> UL Listed US/CAN Hazardous Locations: Class 1 Division 2 Groups ABCD IECEX, ATEX Zone 2

Understanding the Part Numbers Nomenclature



The standard part numbers listed below are available at short notice but represent only a small selection of the options offered by the product family. Visit our online configurator to design a perfectly tailored IPC or explore our latest list of standard part numbers. **Visit the Configurator Tools Page**

Standard Part Numbers

Part Number	Product Description	Operating Temperature
RPB6A2N3B0N0A	PACSystems IPC 6010, U300E, 8 GB LPDDR5, 256 GB SSD, Windows 11 IoT 2024	0°C up to 70°C
RPB6A2N3E0N0A	PACSystems IPC 6010, U300E, 8 GB LPDDR5, 256 GB SSD, PACEdge	0°C up to 70°C
RPB6B2N3B0N0A	PACSystems IPC 6010, I3-1315UE, 8 GB LPDDR5, 256 GB SSD, Windows 11 IoT 2024	0°C up to 70°C
RPB6B2N3E0N0A	PACSystems IPC 6010, I3-1315UE, 8 GB LPDDR5, 256 GB SSD, PACEdge	0°C up to 70°C
RPB7P3N3N0N0F	PACSystems IPC 7010, i5-1350PRE, 16 GB LPDDR5, 256 GB SSD	-40°C up to 70°C
RPB7P3N3B0N0F	PACSystems IPC 7010, i5-1350PRE, 16 GB LPDDR5, 256 GB SSD, Windows 11 IoT 2024	-40°C up to 70°C
RPB8W5N4E0N0F	PACSystems IPC 8010, i7-13800HRE, 64 GB LPDDR5, 512 GB SSD, PACEdge	-40°C up to 70°C
RPB8W5N4B0N0F	PACSystems IPC 8010, i7-13800HRE, 64 GB LPDDR5, 512 GB SSD, Windows 11 IoT 2024	-40°C up to 70°C
RPB8W5N4B0L0F	PACSystems IPC 8010, i7-13800HRE, 64 GB LPDDR5, 512 GB SSD, Windows 11 IoT 2024, WiFi + AI + NVRAM	-40°C up to 70°C

Slot Extensions

Part Number	Product	Product Description
RPE141A0A0A0F	PACSystems IPC Slot Extension - 1 Slots	PACSystems IPC Extension Unit; 1 PCIe Slots; PERC41; no PCIe Card; -40°C up to 70°C - extended temperature
RPE242A0A0A0F	PACSystems IPC Slot Extension - 2 Slots	PACSystems IPC Extension Unit; 2 PCIe Slots; PERC42; no PCIe Card; -40°C up to 70°C - extended temperature
RPE343A0A0A0F	PACSystems IPC Slot Extension - 3 Slots	PACSystems IPC Extension Unit; 3 PCIe Slots; PERC43; no PCIe Card; -40°C up to 70°C - extended temperature
RPE444A0A0A0F	PACSystems IPC Slot Extension - 4 Slots	PACSystems IPC Extension Unit; 4 PCIe Slots; PERC44; no PCIe Card; -40°C up to 70°C - extended temperature

Mounting and Accessories

Part Number	Product Description
R2B00ACCRM01	PACSystems IPC DIN Rail Mounting Kit
R2B00ACMP01	PACSystems IPC Panel Mounting Kit
RPF120	PACSystems IPC Fan Accessory

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